

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Yung-Tsai CHUO	12/19/2007
RECEIVING PARTY DATA	
Name:	HIWIN MIKROSYSTEM CORP.
Street Address:	No. 1, 6th Rd., Taichung Industry Park
City:	Taichung
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29299234
CORRESPONDENCE DATA	
Fax Number:	(361)579-9966
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	281-265-9179
Email:	BS@PAT-BANGSHIA.COM
Correspondent Name:	Dr. BANGER SHIA
Address Line 1:	102 Lindencrest Ct
Address Line 4:	Sugar Land, TEXAS 77479-5201
ATTORNEY DOCKET NUMBER:	CFP-3804 (C-340)
NAME OF SUBMITTER:	BANGER SHIA
Total Attachments: 3 source=CFP-3804-ASSIGN-1#page1.tif source=CFP-3804-ASSIGN-2#page1.tif source=CFP-3804-ASSING-3#page1.tif	

OP \$40.00 29299234

500425508

PATENT
REEL: 020278 FRAME: 0702

ASSIGNMENT DEED

ASSIGNOR:

CHUO, YUNG-TSAI
NO.1,6TH ROAD, TAICHUNG INDUSTRIAL PARK, TAICHUNG 407,
TAIWAN.

ASSIGNEE:

HIWIN MIKROSYSTEM CORP.
NO. 1, 6TH RD., TAICHUNG INDUSTRY PARK, TAICHUNG,
TAIWAN.

Whereas, CHUO, YUNG-TSAI
whose address is set forth above (hereinafter referred to as "Assignor", consideration of payment to it of the sum of Ten U.S. Dollars (U.S.\$10.00) and for other good and valuable consideration, receipt and sufficiency of which are acknowledged hereby; received from

HIWIN MIKROSYSTEM CORP., whose
address is set forth above (hereinafter referred to as "Assignee");

Assignor has sold, assigned, and conveyed and hereby does evidence such sale, assignment and conveyance unto said Assignee, its successors and/or assigns, Assignor's entire right, title and interest —

(1) In and to an invention entitled _____

as described in United States Patent Application Serial No. _____, filed on
_____; which issued into United States Letters Patent No.
_____ on _____, including the right to recover for
past infringements thereof.

(2) In and to said Application for Letters Patent and said Letters Patent No.
_____ which issued _____ on said Application and any and
all other applications for letters patent of the United States of America (including renewal,
divisional, continuation, continuation-in-part, substitute and reissue applications) based upon
said invention, including extensions and reissues, if any, to the full ends of the terms for
which said Letters Patent of the United states has been granted.

(3) In and to all applications for said invention, now or hereafter filed in countries
foreign to the United States of America, and in and to any and all letters patent granted on
said applications to the full ends of the terms for which said Letters Patent may be granted.

Assignor further covenants and agrees that it has not executed and will not execute any
documents in conflict herewith, and it further agrees that it will at any time upon request by
Assignees execute and deliver any and all papers that may be necessary or desirable to perfect
title to said invention, Application for Letters Patent, and the Letters Patent to Assignees, and
if Assignees desires to file one or more divisional, continuation, continuation-in-part, or
substitute applications of or for said Letters Patent of the United States of America, or to
secure a reissue or extension of such Letters Patent, or to file a disclaimer relating thereto,
Assignors will upon request by Assignees sign all papers, make all rightful oaths and do all
lawful acts requisite of it for such reissue or extension, or the procuring thereof, and for the
filing of such disclaimer, but at the expense of Assignees, its successors and/or assigns.

Assignor further agrees that it will at any time upon request by Assignee communicate

to Assignee any facts relating to said invention and Letters Patent or the history thereof, know to Assignor and cause its agent(s) to testify to the same in any interference or any litigation when requested so to do by Assignee.

And the Commissioner of Patents and Trademarks of the United States of America and comparable officials in countries foreign to the United States of America to record and/or issue said Letters Patent, and the like to Assignee as assignee of Assignor's entire right, title and interest therein.

Signed at TAICHUNG, TAIWAN this 19TH day
of DEC. 2007.

Assignor:

By  _____

Name : CHUO, YUNG-TSAI

Title : INVENTOR(S)

Date : DEC. 19, 2007

Witness:

Signature: _____

Name :

Address :

Date: